

2A, 100V-600V Super Fast Surface Mount Rectifier

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Low power loss, high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Freewheeling application
- Switching mode converters and inverters, computer and telecommunication.

MECHANICAL DATA

- Case: SOD-128
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.028g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	2	A
V_{RRM}	100 - 600	V
I_{FSM}	50	A
T_{JMAX}	150	°C
Package	SOD-128	
Configuration	Single die	



SOD-128



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	ES2BFS	ES2DFS	ES2GFS	ES2JFS	UNIT
Marking code on the device		ES2BFS	ES2DFS	ES2GFS	ES2JFS	
Repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V
Reverse voltage, total rms value	$V_{R(RMS)}$	70	140	280	420	V
Forward current	I_F	2				A
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms	I_{FSM} 50				A
	t = 1.0ms	120				A
Junction temperature	T_J	-55 to +150				°C
Storage temperature	T_{STG}	-55 to +150				°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	24	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	72	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	14	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	ES2BFS ES2DFS	I _F = 1.0A, T _J = 25°C	V _F	0.82	-	V
		I _F = 2.0A, T _J = 25°C		0.88	0.95	V
		I _F = 1.0A, T _J = 125°C		0.66	-	V
		I _F = 2.0A, T _J = 125°C		0.74	0.84	V
	ES2GFS	I _F = 1.0A, T _J = 25°C		0.89	-	V
		I _F = 2.0A, T _J = 25°C		0.97	1.30	V
		I _F = 1.0A, T _J = 125°C		0.72	-	V
		I _F = 2.0A, T _J = 125°C		0.81	0.91	V
	ES2JFS	I _F = 1.0A, T _J = 25°C		1.11	-	V
		I _F = 2.0A, T _J = 25°C		1.24	1.70	V
		I _F = 1.0A, T _J = 125°C		0.86	-	V
		I _F = 2.0A, T _J = 125°C		1.01	1.14	V
Reverse current @ rated V _R ⁽²⁾		T _J = 25°C	I _R	-	1	μA
		T _J = 125°C		-	25	μA
Reverse recovery time		I _F = 0.5A, I _R = 1.0A, I _{rr} = 0.25A	t _{rr}	-	35	ns
Junction capacitance	ES2BFS ES2DFS	1MHz, V _R = 4.0V	C _J	28	-	pF
	ES2GFS			27	-	pF
	ES2JFS			21	-	pF

Notes:

(1) Pulse test with $PW = 0.3\text{ms}$

(2) Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
ES2xFS M3G	SOD-128	3,500 / 7" reel
ES2xFS M2G	SOD-128	14,000 / 13" reel

Notes:

(1) "x" defines voltage from 100V(ES2BFS) to 600V(ES2JFS)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

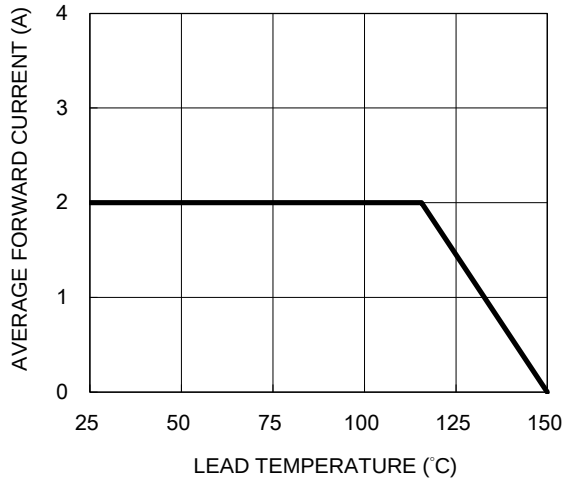


Fig.2 Typical Junction Capacitance

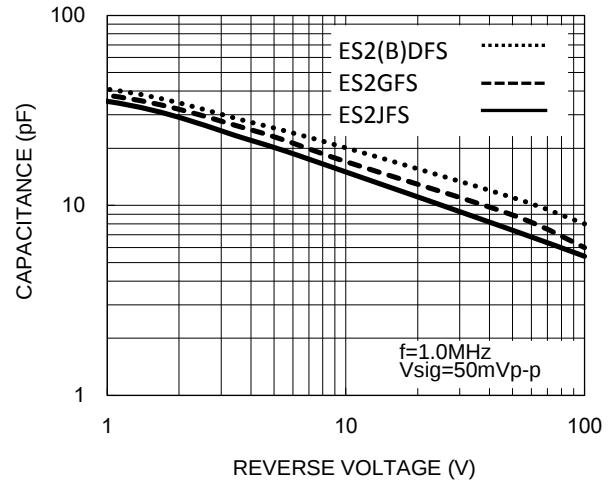


Fig.3 Typical Reverse Characteristics

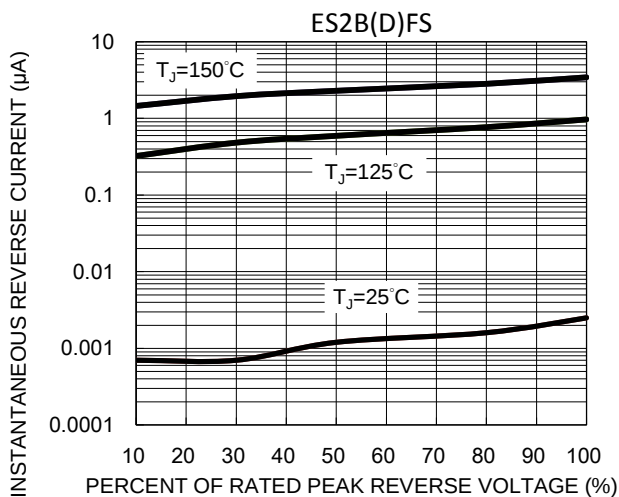


Fig.4 Typical Forward Characteristics

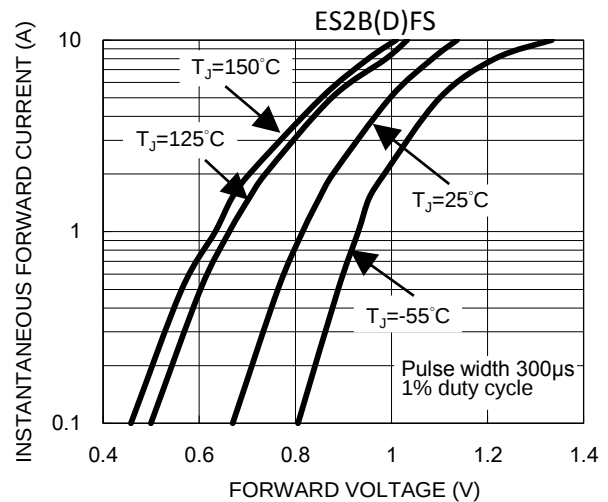


Fig.5 Typical Reverse Characteristics

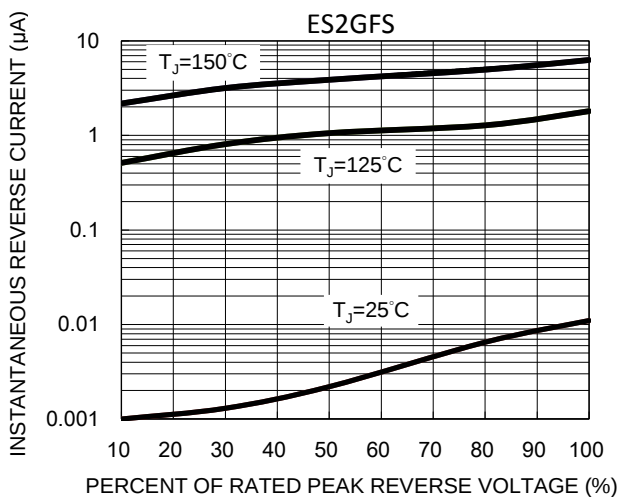


Fig.6 Typical Forward Characteristics

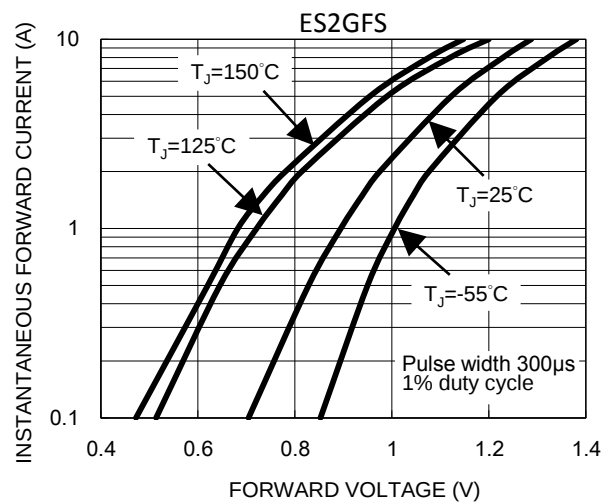


Fig.7 Typical Reverse Characteristics

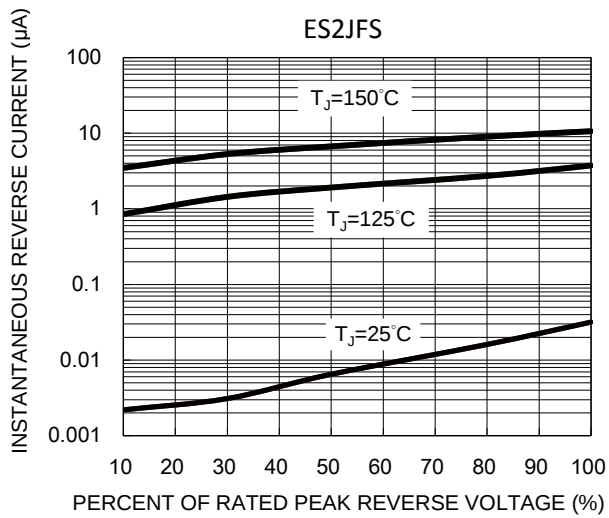


Fig.8 Typical Forward Characteristics

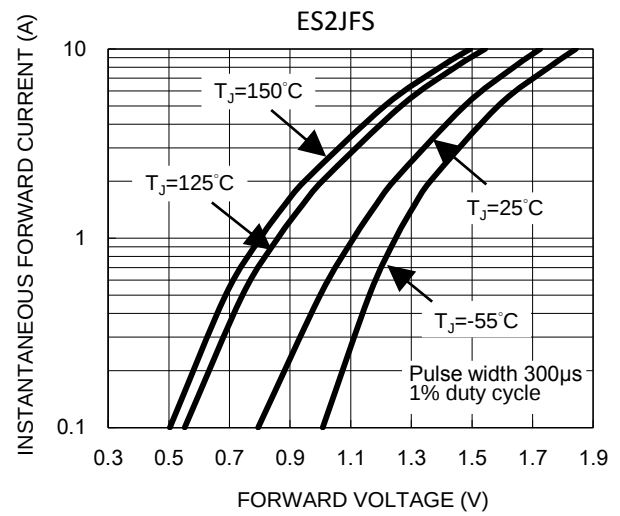
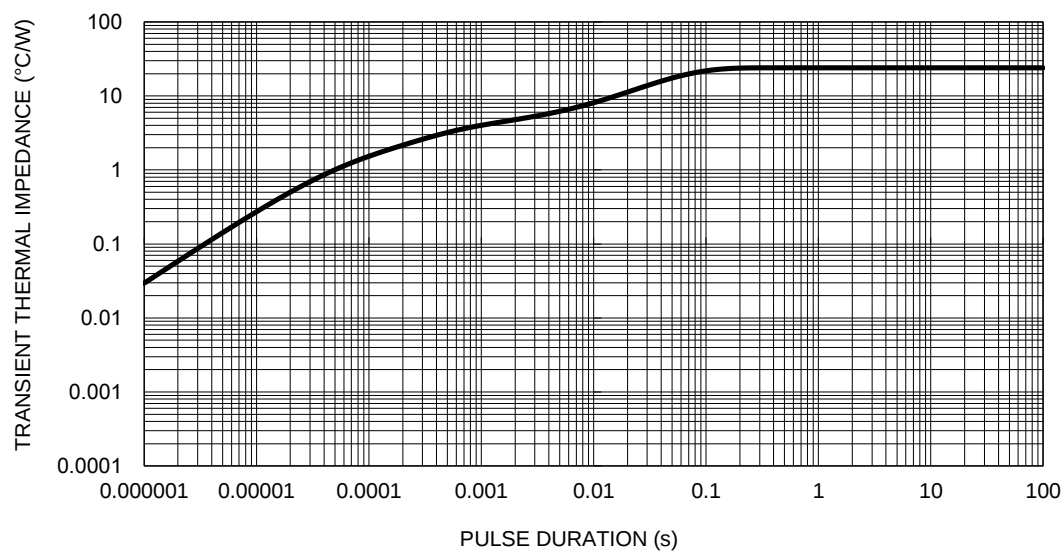
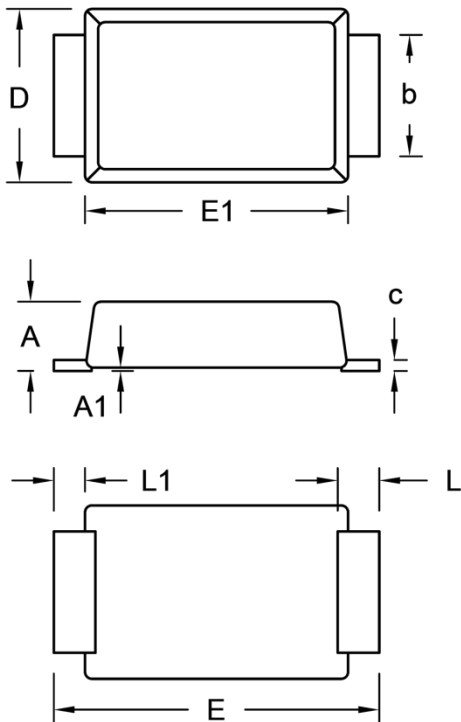


Fig.9 Typical Transient Thermal Impedance



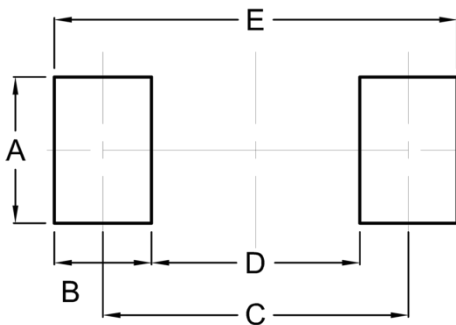
PACKAGE OUTLINE DIMENSIONS

SOD-128



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	0.90	1.10	0.035	0.043
A1	0.00	0.10	0.000	0.004
b	1.60	1.90	0.063	0.075
c	0.10	0.22	0.004	0.009
D	2.30	2.70	0.091	0.106
E	4.40	5.00	0.173	0.197
E1	3.60	4.00	0.142	0.157
L	0.40	0.80	0.016	0.031
L1	0.30	0.60	0.012	0.024

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.10	0.083
B	1.40	0.055
C	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N = Marking Code
 YW = Date Code
 F = Factory Code

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